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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Discontinued at Digi-Key
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	59
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2136ccnfa-v0

Table 1.5 Pin Name Information by Pin Number (1)

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	I ² C bus	A/D Converter, D/A Converter, Comparator B
1		P3_0		(TRA0/TRGCLKA)				
2		P4_2						VREF
3	MODE							
4	(XCIN)	P4_3						
5	(XCOUT)	P4_4						
6	RESET							
7	XOUT	P4_7						
8	VSS/AVSS							
9	XIN	P4_6						
10	VCC/AVCC							
11		P5_4		(TRCIOD)				
12		P5_3		(TRCIOC)				
13		P5_2		(TRCIOB)				
14		P5_1		(TRCIOA/TRCTRG)				
15		P5_0		(TRCCLK)				
16		P3_7		TRA0	(TXD2/SDA2/ RXD2/SCL2)	SSO	SDA	
17		P3_5		(TRCIOD)	(CLK2)	SSCK	SCL	
18		P3_4		(TRCIOC)	(TXD2/SDA2/ RXD2/SCL2)	SSI		IVREF3
19		P3_3	INT3	(TRCCLK)	(CTS2/RTS2)	SCS		IVCMP3
20		P2_7		(TRDIOD1)				
21		P2_6		(TRDIOC1)				
22		P2_5		(TRDIOB1)				
23		P2_4		(TRDIOA1)				
24		P2_3		(TRDIOD0)				
25		P2_2		(TRCIOD/TRDIOB0)				
26		P2_1		(TRCIOC/TRDIOC0)				
27		P2_0	(INT1)	(TRCIOB/TRDIOA0/ TRDCLK)				
28		P3_6	(INT1)					
29		P3_1		(TRBO)				
30		P8_6						
31		P8_5		(TRFO12)				
32		P8_4		(TRFO11)				
33		P8_3		(TRFI/TRFO10)				
34		P8_2		(TRFO02)				
35		P8_1		(TRFO01)				
36		P8_0		(TRFO00)				
37		P6_7	(INT3)	(TRCIOD)				
38		P6_6	INT2	(TRCIOC)	(TXD2/SDA2)			
39		P6_5	INT4	(TRCIOB)	(CLK2/CLK1)			

Note:

1. Can be assigned to the pin in parentheses by a program.

Table 1.6 Pin Name Information by Pin Number (2)

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	I ² C bus	A/D Converter, D/A Converter, Comparator B
40		P4_5	INT0		(RXD2/SCL2)			ADTRG
41		P1_7	INT1	(TRAIO)				IVCMP1
42		P1_6			(CLK0)			IVREF1
43		P1_5	(INT1)	(TRAIO)	(RXD0)			
44		P1_4		(TRCCLK)	(TXD0)			
45		P1_3	KI3	TRBO (/TRCIOB)				AN11
46		P1_2	KI2	(TRCIOB)				AN10
47		P1_1	KI1	(TRCIOA/TRCTRG)				AN9
48		P1_0	KI0	(TRCIOD)				AN8
49		P0_7		(TRCIOB)				AN0/DA1
50		P0_6		(TRCIOD)				AN1/DA0
51		P0_5		(TRCIOB)				AN2
52		P0_4		TREO(/TRCIOB)				AN3
53		P0_3		(TRCIOB)	(CLK1)			AN4
54		P0_2		(TRCIOA/TRCTRG)	(RXD1)			AN5
55		P0_1		(TRCIOA/TRCTRG)	(TXD1)			AN6
56		P0_0		(TRCIOA/TRCTRG)				AN7
57		P6_4			(RXD1)			
58		P6_3			(TXD1)			
59		P6_2			(CLK1)			
60		P6_1						
61		P6_0		(TREO)				
62		P5_7		(TRGIOB)				
63		P5_6		(TRAO/TRGIOA)				
64		P3_2	(INT1/ INT2)	(TRAIO/TRGCLKB)				

Note:

1. Can be assigned to the pin in parentheses by a program.

3. Memory

3.1 R8C/36C Group

Figure 3.1 is a Memory Map of R8C/36C Group. The R8C/36C Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 64-Kbyte internal ROM area is allocated addresses 04000h to 13FFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.

The internal ROM (data flash) is allocated addresses 03000h to 03FFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 6-Kbyte internal RAM area is allocated addresses 00400h to 01BFFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh (the SFR areas for the DTC and other modules). Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.

Table 4.4 SFR Information (4) ⁽¹⁾

Address	Register	Symbol	After Reset
00C0h	A/D Register 0	AD0	XXh
00C1h			000000XXb
00C2h			XXh
00C3h	A/D Register 1	AD1	000000XXb
00C4h			XXh
00C5h			000000XXb
00C6h	A/D Register 2	AD2	XXh
00C7h			000000XXb
00C8h			XXh
00C9h	A/D Register 3	AD3	000000XXb
00CAh			XXh
00CBh			000000XXb
00CCh	A/D Register 4	AD4	XXh
00CDh			000000XXb
00CEh			XXh
00CFh	A/D Register 5	AD5	000000XXb
00D0h			XXh
00D1h			000000XXb
00D2h	A/D Register 6	AD6	XXh
00D3h			000000XXb
00D4h			XXh
00D5h	A/D Register 7	AD7	000000XXb
00D6h			XXh
00D7h			000000XXb
00D8h	A/D Mode Register	ADMOD	00h
00D9h			11000000b
00DAh			00h
00DBh	A/D Input Select Register	ADINSEL	00h
00DCh			00h
00DDh			00h
00DEh	A/D Control Register 0	ADCON0	00h
00DFh			00h
00E0h			00h
00E1h	A/D Control Register 1	ADCON1	00h
00E2h			00h
00E3h			00h
00E4h	D/A0 Register	DA0	00h
00E5h			00h
00E6h			00h
00E7h	D/A1 Register	DA1	00h
00E8h			00h
00E9h			00h
00EAh	D/A Control Register	DACON	00h
00EBh			00h
00ECh			00h
00EDh	Port P0 Register	P0	XXh
00EEh			XXh
00EFh			00h
00F0h	Port P1 Register	P1	00h
00F1h			00h
00F2h			00h
00F3h	Port P0 Direction Register	PD0	00h
00F4h			00h
00F5h			00h
00F6h	Port P1 Direction Register	PD1	00h
00F7h			00h
00F8h			00h
00F9h	Port P2 Register	P2	XXh
00FAh			XXh
00FBh			00h
00FCh	Port P3 Register	P3	00h
00FDh			00h
00FEh			00h
00FFh	Port P2 Direction Register	PD2	00h
			00h
			00h
	Port P3 Direction Register	PD3	00h
			00h
			00h
	Port P4 Register	P4	XXh
			XXh
			00h
	Port P5 Register	P5	00h
			00h
			00h
	Port P4 Direction Register	PD4	00h
			00h
			00h
	Port P5 Direction Register	PD5	00h
			00h
			00h
	Port P6 Register	P6	XXh
			XXh
			00h
	Port P6 Direction Register	PD6	00h
			00h
			00h
	Port P8 Register	P8	XXh
			XXh

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.6 SFR Information (6) (1)

Address	Register	Symbol	After Reset
0140h	Timer RD Control Register 0	TRDCR0	00h
0141h	Timer RD I/O Control Register A0	TRDIORA0	10001000b
0142h	Timer RD I/O Control Register C0	TRDIORC0	10001000b
0143h	Timer RD Status Register 0	TRDSR0	11100000b
0144h	Timer RD Interrupt Enable Register 0	TRDIER0	11100000b
0145h	Timer RD PWM Mode Output Level Control Register 0	TRDPOCR0	11111000b
0146h	Timer RD Counter 0	TRD0	00h
0147h			00h
0148h	Timer RD General Register A0	TRDGRA0	FFh
0149h			FFh
014Ah	Timer RD General Register B0	TRDGRB0	FFh
014Bh			FFh
014Ch	Timer RD General Register C0	TRDGRC0	FFh
014Dh			FFh
014Eh	Timer RD General Register D0	TRDGRD0	FFh
014Fh			FFh
0150h	Timer RD Control Register 1	TRDCR1	00h
0151h	Timer RD I/O Control Register A1	TRDIORA1	10001000b
0152h	Timer RD I/O Control Register C1	TRDIORC1	10001000b
0153h	Timer RD Status Register 1	TRDSR1	11000000b
0154h	Timer RD Interrupt Enable Register 1	TRDIER1	11100000b
0155h	Timer RD PWM Mode Output Level Control Register 1	TRDPOCR1	11111000b
0156h	Timer RD Counter 1	TRD1	00h
0157h			00h
0158h	Timer RD General Register A1	TRDGRA1	FFh
0159h			FFh
015Ah	Timer RD General Register B1	TRDGRB1	FFh
015Bh			FFh
015Ch	Timer RD General Register C1	TRDGRC1	FFh
015Dh			FFh
015Eh	Timer RD General Register D1	TRDGRD1	FFh
015Fh			FFh
0160h	UART1 Transmit/Receive Mode Register	U1MR	00h
0161h	UART1 Bit Rate Register	U1BRG	XXh
0162h	UART1 Transmit Buffer Register	U1TB	XXh
0163h			XXh
0164h	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
0165h	UART1 Transmit/Receive Control Register 1	U1C1	00000010b
0166h	UART1 Receive Buffer Register	U1RB	XXh
0167h			XXh
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h	Timer RG Mode Register	TRGMR	01000000b
0171h	Timer RG Count Control Register	TRGCNTC	00h
0172h	Timer RG Control Register	TRGCR	10000000b
0173h	Timer RG Interrupt Enable Register	TRGIER	11110000b
0174h	Timer RG Status Register	TRGSR	11100000b
0175h	Timer RG I/O Control Register	TRGIOR	00h
0176h	Timer RG Counter	TRG	00h
0177h			00h
0178h	Timer RG General Register A	TRGGRA	FFh
0179h			FFh
017Ah	Timer RG General Register B	TRGGRB	FFh
017Bh			FFh
017Ch	Timer RG General Register C	TRGGRC	FFh
017Dh			FFh
017Eh	Timer RG General Register D	TRGGRD	FFh
017Fh			FFh

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.7 SFR Information (7) ⁽¹⁾

Address	Register	Symbol	After Reset
0180h	Timer RA Pin Select Register	TRASR	00h
0181h	Timer RB/RC Pin Select Register	TRBRCSR	00h
0182h	Timer RC Pin Select Register 0	TRCPSR0	00h
0183h	Timer RC Pin Select Register 1	TRCPSR1	00h
0184h	Timer RD Pin Select Register 0	TRDPSR0	00h
0185h	Timer RD Pin Select Register 1	TRDPSR1	00h
0186h	Timer Pin Select Register	TIMSR	00h
0187h	Timer RF Output Control Register	TRFOUT	00h
0188h	UART0 Pin Select Register	U0SR	00h
0189h	UART1 Pin Select Register	U1SR	00h
018Ah	UART2 Pin Select Register 0	U2SR0	00h
018Bh	UART2 Pin Select Register 1	U2SR1	00h
018Ch	SSU/IIC Pin Select Register	SSUIICSR	00h
018Dh			
018Eh	INT Interrupt Input Pin Select Register	INTSR	00h
018Fh	I/O Function Pin Select Register	PINSR	00h
0190h			
0191h			
0192h			
0193h	SS Bit Counter Register	SSBR	11111000b
0194h	SS Transmit Data Register L / IIC bus Transmit Data Register ⁽²⁾	SSTDRL / ICDRT	FFh
0195h	SS Transmit Data Register H ⁽²⁾	SSTDRLH	FFh
0196h	SS Receive Data Register L / IIC bus Receive Data Register ⁽²⁾	SSRDL / ICDRL	FFh
0197h	SS Receive Data Register H ⁽²⁾	SSRDLH	FFh
0198h	SS Control Register H / IIC bus Control Register 1 ⁽²⁾	SSCRH / ICCR1	00h
0199h	SS Control Register L / IIC bus Control Register 2 ⁽²⁾	SSCRL / ICCR2	01111101b
019Ah	SS Mode Register / IIC bus Mode Register ⁽²⁾	SSMR / ICMR	00010000b / 00011000b
019Bh	SS Enable Register / IIC bus Interrupt Enable Register ⁽²⁾	SSER / ICIE	00h
019Ch	SS Status Register / IIC bus Status Register ⁽²⁾	SSSR / ICSR	00h / 0000X000b
019Dh	SS Mode Register 2 / Slave Address Register ⁽²⁾	SSMR2 / SAR	00h
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			
01ADh			
01AEh			
01AFh			
01B0h			
01B1h			
01B2h	Flash Memory Status Register	FST	10000X00b
01B3h			
01B4h	Flash Memory Control Register 0	FMR0	00h
01B5h	Flash Memory Control Register 1	FMR1	00h
01B6h	Flash Memory Control Register 2	FMR2	00h
01B7h			
01B8h			
01B9h			
01BAh			
01BBh			
01BCh			
01BDh			
01BEh			
01BFh			

X: Undefined

Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. Selectable by the IICSEL bit in the SSUIICSR register.

Table 5.4 D/A Converter Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
—	Resolution		—	—	8	Bit
—	Absolute accuracy		—	—	2.5	LSB
t_{su}	Setup time		—	—	3	μs
R_o	Output resistor		—	6	—	$k\Omega$
I_{vref}	Reference power input current	(Note 2)	—	—	1.5	mA

Notes:

1. $V_{CC}/AV_{CC} = V_{ref} = 2.7$ to 5.5 V and $T_{opr} = -20$ to 85 °C (N version)/ -40 to 85 °C (D version), unless otherwise specified.
2. This applies when one D/A converter is used and the value of the DAi register ($i = 0$ or 1) for the unused D/A converter is 00h. The resistor ladder of the A/D converter is not included.

Table 5.5 Comparator B Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V_{ref}	IVREF1, IVREF3 input reference voltage		0	—	$V_{CC} - 1.4$	V
V_i	IVCMP1, IVCMP3 input voltage		-0.3	—	$V_{CC} + 0.3$	V
—	Offset		—	5	100	mV
t_d	Comparator output delay time ⁽²⁾	$V_i = V_{ref} \pm 100$ mV	—	0.1	—	μs
I_{CMP}	Comparator operating current	$V_{CC} = 5.0$ V	—	17.5	—	μA

Notes:

1. $V_{CC} = 2.7$ to 5.5 V and $T_{opr} = -20$ to 85 °C (N version)/ -40 to 85 °C (D version), unless otherwise specified.
2. When the digital filter is disabled.

Table 5.6 Flash Memory (Program ROM) Electrical Characteristics

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
—	Program/erase endurance ⁽²⁾		1,000 ⁽³⁾	—	—	times
—	Byte program time		—	80	500	μs
—	Block erase time		—	0.3	—	s
t _d (SR-SUS)	Time delay from suspend request until suspend		—	—	5 + CPU clock × 3 cycles	ms
—	Interval from erase start/restart until following suspend request		0	—	—	μs
—	Time from suspend until erase restart		—	—	30 + CPU clock × 1 cycle	μs
t _d (CMDRST-READY)	Time from when command is forcibly stopped until reading is enabled		—	—	30 + CPU clock × 1 cycle	μs
—	Program, erase voltage		2.7	—	5.5	V
—	Read voltage		1.8	—	5.5	V
—	Program, erase temperature		0	—	60	°C
—	Data hold time ⁽⁷⁾	Ambient temperature = 55 °C	20	—	—	year

Notes:

1. V_{CC} = 2.7 to 5.5 V and T_{opr} = 0 to 60 °C, unless otherwise specified.
2. Definition of programming/erasure endurance
The programming and erasure endurance is defined on a per-block basis.
If the programming and erasure endurance is n (n = 1,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed.)
4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.15 Timing Requirements of Synchronous Serial Communication Unit (SSU)

Symbol	Parameter		Conditions	Standard			Unit
				Min.	Typ.	Max.	
tsucyc	SSCK clock cycle time			4	—	—	tcyc (2)
tHI	SSCK clock "H" width			0.4	—	0.6	tsucyc
tLO	SSCK clock "L" width			0.4	—	0.6	tsucyc
tRISE	SSCK clock rising time	Master		—	—	1	tcyc (2)
		Slave		—	—	1	μs
tFALL	SSCK clock falling time	Master		—	—	1	tcyc (2)
		Slave		—	—	1	μs
tsu	SSO, SSI data input setup time			100	—	—	ns
tH	SSO, SSI data input hold time			1	—	—	tcyc (2)
tLEAD	SCS setup time	Slave		1tcyc + 50	—	—	ns
tLAG	SCS hold time	Slave		1tcyc + 50	—	—	ns
tOD	SSO, SSI data output delay time			—	—	1	tcyc (2)
tsA	SSI slave access time		2.7 V ≤ Vcc ≤ 5.5 V	—	—	1.5tcyc + 100	ns
			1.8 V ≤ Vcc < 2.7 V	—	—	1.5tcyc + 200	ns
toR	SSI slave out open time		2.7 V ≤ Vcc ≤ 5.5 V	—	—	1.5tcyc + 100	ns
			1.8 V ≤ Vcc < 2.7 V	—	—	1.5tcyc + 200	ns

Notes:

1. Vcc = 1.8 to 5.5 V, Vss = 0 V, and T_{opr} = −20 to 85 °C (N version)/−40 to 85 °C (D version), unless otherwise specified.
2. 1tcyc = 1/f1(s)

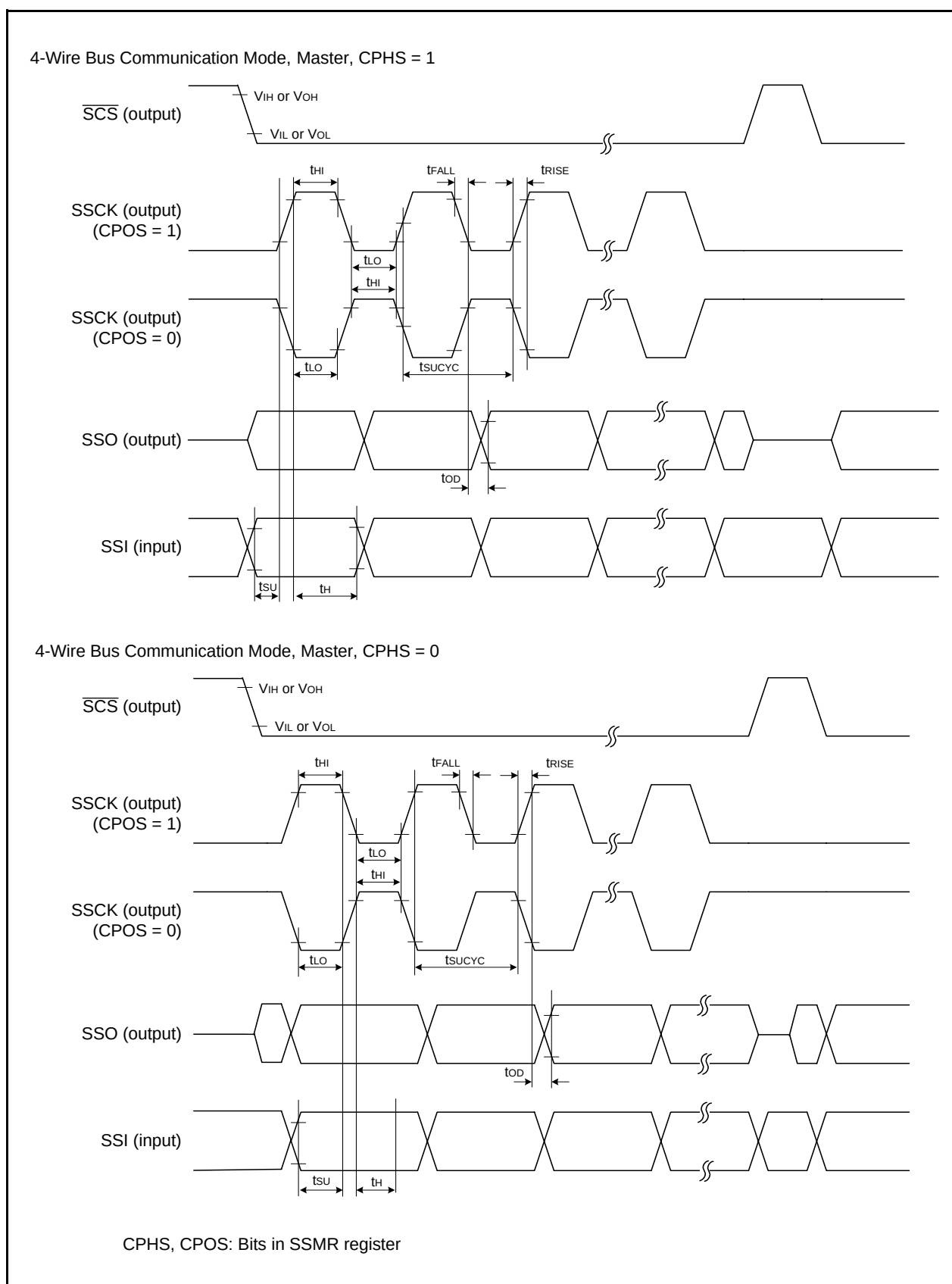


Figure 5.4 I/O Timing of Synchronous Serial Communication Unit (SSU) (Master)

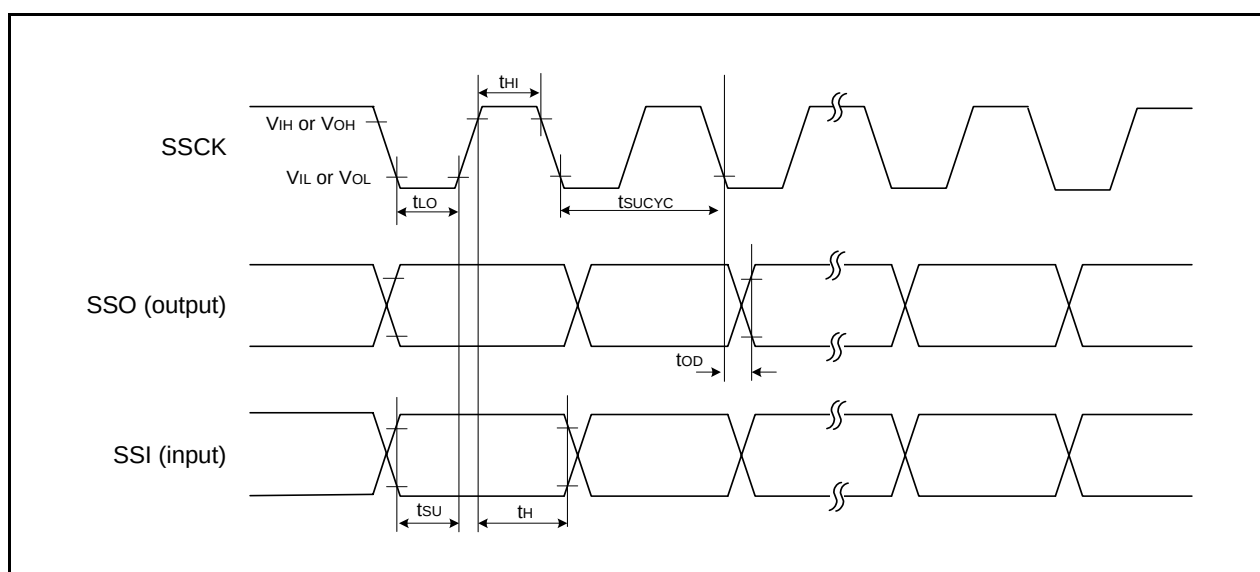


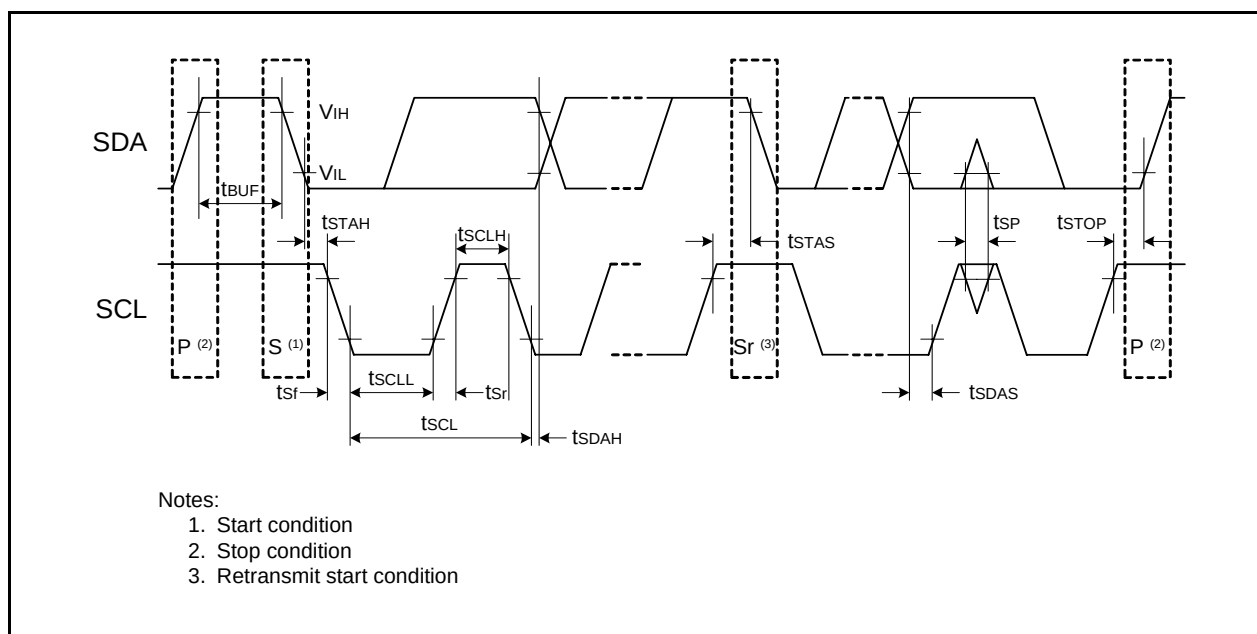
Figure 5.6 I/O Timing of Synchronous Serial Communication Unit (SSU) (Clock Synchronous Communication Mode)

Table 5.16 Timing Requirements of I²C bus Interface

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
t _{SCL}	SCL input cycle time		12t _{cyC} + 600 ⁽²⁾	—	—	ns
t _{SCLH}	SCL input "H" width		3t _{cyC} + 300 ⁽²⁾	—	—	ns
t _{SCLL}	SCL input "L" width		5t _{cyC} + 500 ⁽²⁾	—	—	ns
t _{sf}	SCL, SDA input fall time		—	—	300	ns
t _{SP}	SCL, SDA input spike pulse rejection time		—	—	1t _{cyC} ⁽²⁾	ns
t _{BUF}	SDA input bus-free time		5t _{cyC} ⁽²⁾	—	—	ns
t _{STAH}	Start condition input hold time		3t _{cyC} ⁽²⁾	—	—	ns
t _{STAS}	Retransmit start condition input setup time		3t _{cyC} ⁽²⁾	—	—	ns
t _{STOP}	Stop condition input setup time		3t _{cyC} ⁽²⁾	—	—	ns
t _{SDAS}	Data input setup time		1t _{cyC} + 40 ⁽²⁾	—	—	ns
t _{SDAH}	Data input hold time		10	—	—	ns

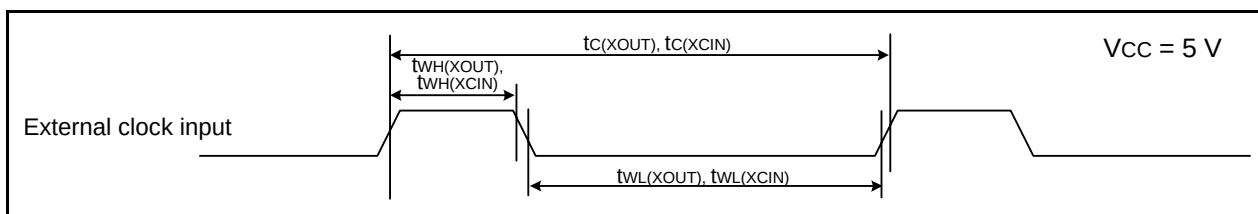
Notes:

1. V_{CC} = 1.8 to 5.5 V, V_{SS} = 0 V, and T_{opr} = -20 to 85 °C (N version)/-40 to 85 °C (D version), unless otherwise specified.
2. 1t_{cyC} = 1/f₁(s)

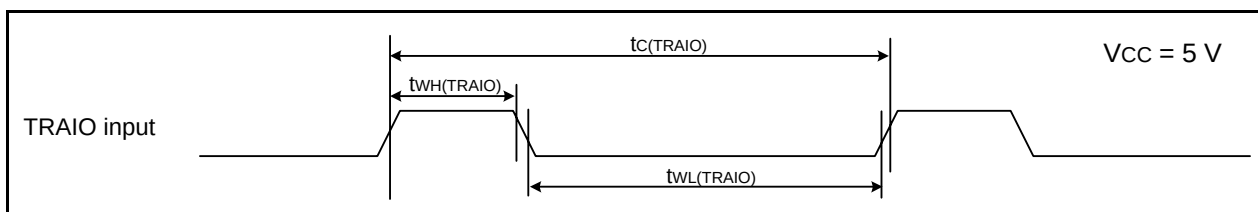
**Figure 5.7 I/O Timing of I²C bus Interface**

Timing Requirements (Unless Otherwise Specified: $V_{CC} = 5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_{opr} = 25\text{ }^{\circ}\text{C}$)**Table 5.19 External Clock Input (XOUT, XCIN)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(XOUT)}$	XOUT input cycle time	50	—	ns
$t_{WH(XOUT)}$	XOUT input "H" width	24	—	ns
$t_{WL(XOUT)}$	XOUT input "L" width	24	—	ns
$t_{c(XCIN)}$	XCIN input cycle time	14	—	μs
$t_{WH(XCIN)}$	XCIN input "H" width	7	—	μs
$t_{WL(XCIN)}$	XCIN input "L" width	7	—	μs

**Figure 5.8 External Clock Input Timing Diagram when $V_{CC} = 5\text{ V}$** **Table 5.20 TRAIO Input**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRAIO)}$	TRAIO input cycle time	100	—	ns
$t_{WH(TRAIO)}$	TRAIO input "H" width	40	—	ns
$t_{WL(TRAIO)}$	TRAIO input "L" width	40	—	ns

**Figure 5.9 TRAIO Input Timing Diagram when $V_{CC} = 5\text{ V}$** **Table 5.21 TRFI Input**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRFI)}$	TRFI input cycle time	400 (1)	—	ns
$t_{WH(TRFI)}$	TRFI input "H" width	200 (2)	—	ns
$t_{WL(TRFI)}$	TRFI input "L" width	200 (2)	—	ns

Notes:

1. When using timer RF input capture mode, adjust the cycle time to $(1/\text{timer RF count source frequency} \times 3)$ or above.
2. When using timer RF input capture mode, adjust the pulse width to $(1/\text{timer RF count source frequency} \times 1.5)$ or above.

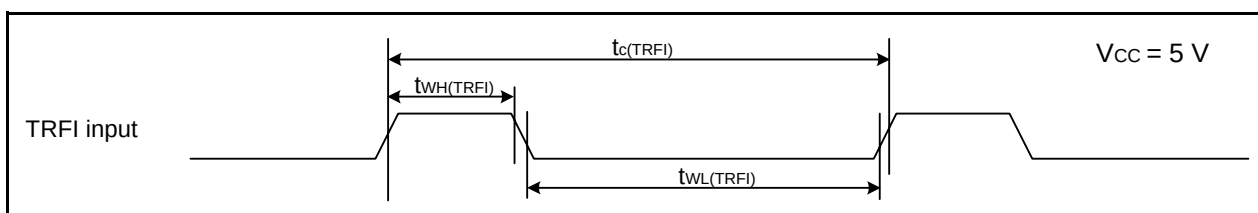
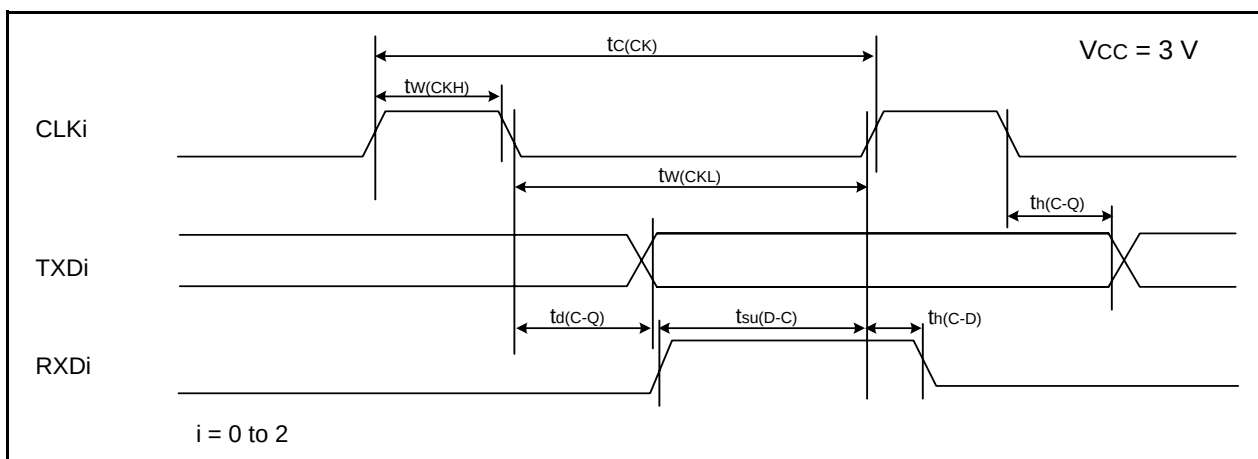
**Figure 5.10 TRFI Input Timing Diagram when $V_{CC} = 5\text{ V}$**

Table 5.29 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi input cycle time	300	—	ns
$t_{w(CKH)}$	CLKi input "H" width	150	—	ns
$t_{w(CKL)}$	CLKi Input "L" width	150	—	ns
$t_{d(C-Q)}$	TXDi output delay time	—	80	ns
$t_{h(C-Q)}$	TXDi hold time	0	—	ns
$t_{su(D-C)}$	RXDi input setup time	70	—	ns
$t_{h(C-D)}$	RXDi input hold time	90	—	ns

 $i = 0 \text{ to } 2$ **Figure 5.16 Serial Interface Timing Diagram when Vcc = 3 V****Table 5.30 External Interrupt $\overline{INTi}$ ($i = 0 \text{ to } 4$) Input, Key Input Interrupt $\overline{Kli}$ ($i = 0 \text{ to } 3$)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ input "H" width, $\overline{Kli}$ input "H" width	380 (1)	—	ns
$t_{w(INL)}$	$\overline{INTi}$ input "L" width, $\overline{Kli}$ input "L" width	380 (2)	—	ns

Notes:

1. When selecting the digital filter by the $\overline{INTi}$ input filter select bit, use an $\overline{INTi}$ input HIGH width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{INTi}$ input filter select bit, use an $\overline{INTi}$ input LOW width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.

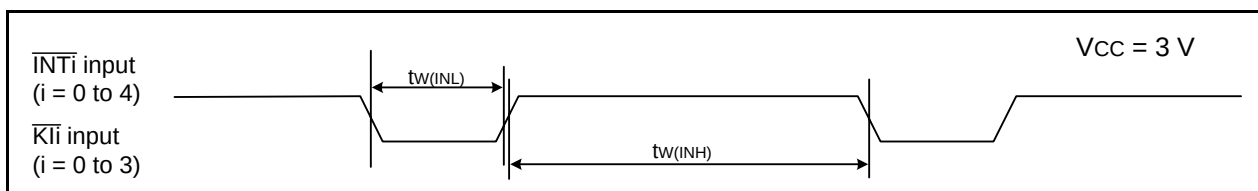
**Figure 5.17 Input Timing Diagram for External Interrupt $\overline{INTi}$ and Key Input Interrupt $\overline{Kli}$ when Vcc = 3 V**

Table 5.31 Electrical Characteristics (5) [$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$]

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V _{OH}	Output "H" voltage	Other than XOUT	Drive capacity High	I _{OH} = -2 mA	V _{CC} - 0.5	—	V _{CC}	V
			Drive capacity Low	I _{OH} = -1 mA	V _{CC} - 0.5	—	V _{CC}	V
		XOUT		I _{OH} = -200 μ A	1.0	—	V _{CC}	V
V _{OL}	Output "L" voltage	Other than XOUT	Drive capacity High	I _{OL} = 2 mA	—	—	0.5	V
			Drive capacity Low	I _{OL} = 1 mA	—	—	0.5	V
		XOUT		I _{OL} = 200 μ A	—	—	0.5	V
V _{T+} -V _{T-}	Hysteresis	$\overline{\text{NT0}}$, $\overline{\text{INT1}}$, $\overline{\text{INT2}}$, $\overline{\text{INT3}}$, $\overline{\text{INT4}}$, $\overline{\text{KI0}}$, $\overline{\text{KI1}}$, $\overline{\text{KI2}}$, $\overline{\text{KI3}}$, $\overline{\text{TRAIO}}$, $\overline{\text{TRBO}}$, $\overline{\text{TRCIOA}}$, $\overline{\text{TRCIOB}}$, $\overline{\text{TRCIOC}}$, $\overline{\text{TRCIOD}}$, $\overline{\text{TRDIOA0}}$, $\overline{\text{TRDIOB0}}$, $\overline{\text{TRDIOC0}}$, $\overline{\text{TRDIOD0}}$, $\overline{\text{TRDIOA1}}$, $\overline{\text{TRDIOB1}}$, $\overline{\text{TRDIOC1}}$, $\overline{\text{TRDIOD1}}$, $\overline{\text{TRCTRG}}$, $\overline{\text{TRCCLK}}$, $\overline{\text{TRFI}}$, $\overline{\text{TRGIOA}}$, $\overline{\text{TRGIOB}}$, $\overline{\text{ADTRG}}$, $\overline{\text{RXD0}}$, $\overline{\text{RXD1}}$, $\overline{\text{RXD2}}$, $\overline{\text{CLK0}}$, $\overline{\text{CLK1}}$, $\overline{\text{CLK2}}$, $\overline{\text{SSI}}$, $\overline{\text{SCL}}$, $\overline{\text{SDA}}$, $\overline{\text{SSO}}$			0.05	0.20	—	V
		$\overline{\text{RESET}}$			0.05	0.20	—	V
I _{IH}	Input "H" current		V _I = 2.2 V, V _{CC} = 2.2 V		—	—	4.0	μ A
I _{IL}	Input "L" current		V _I = 0 V, V _{CC} = 2.2 V		—	—	-4.0	μ A
R _{PULLUP}	Pull-up resistance		V _I = 0 V, V _{CC} = 2.2 V		70	140	300	k Ω
R _{IXIN}	Feedback resistance	XIN			—	0.3	—	M Ω
R _{IXCIN}	Feedback resistance	XCIN			—	8	—	M Ω
V _{RAM}	RAM hold voltage		During stop mode		1.8	—	—	V

Note:

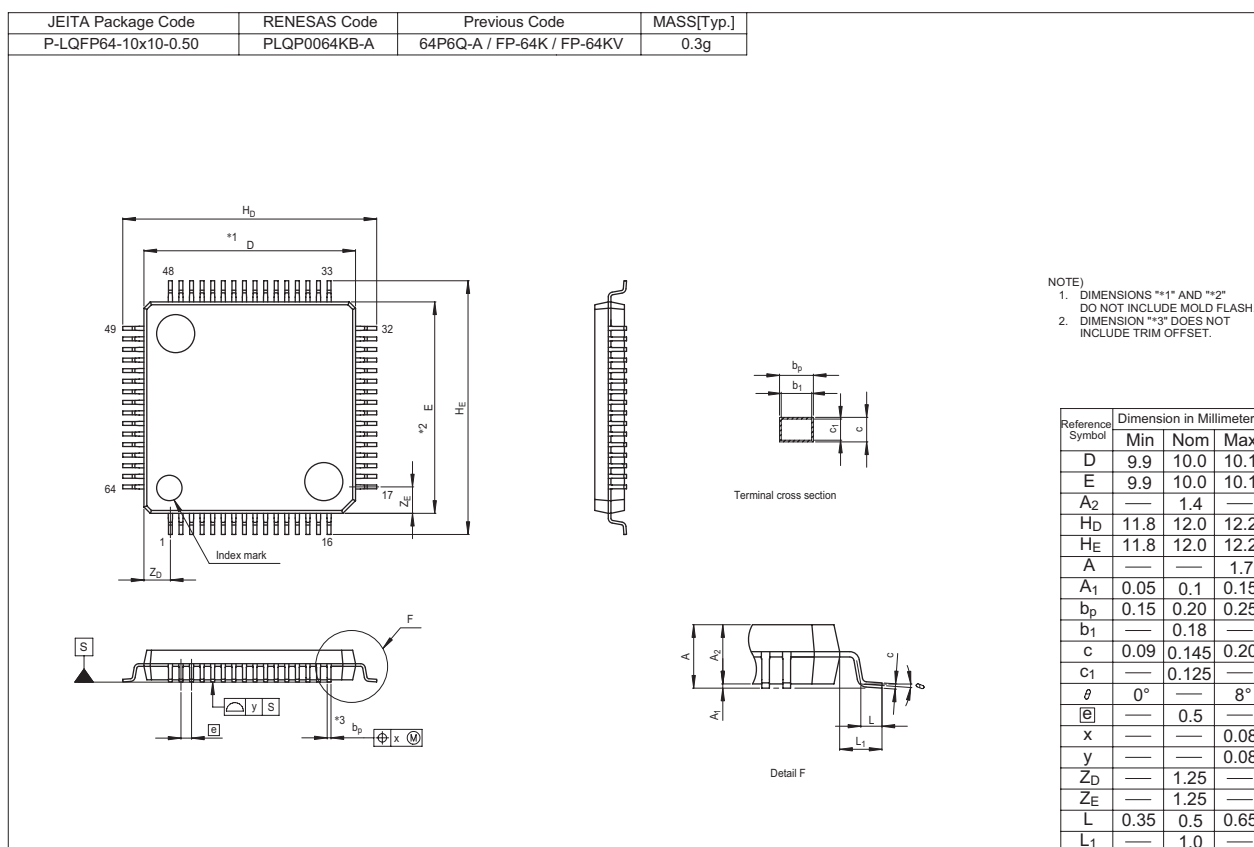
1. $1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$, T_{opr} = -20 to 85 °C (N version)/-40 to 85 °C (D version), and f(XIN) = 5 MHz, unless otherwise specified.

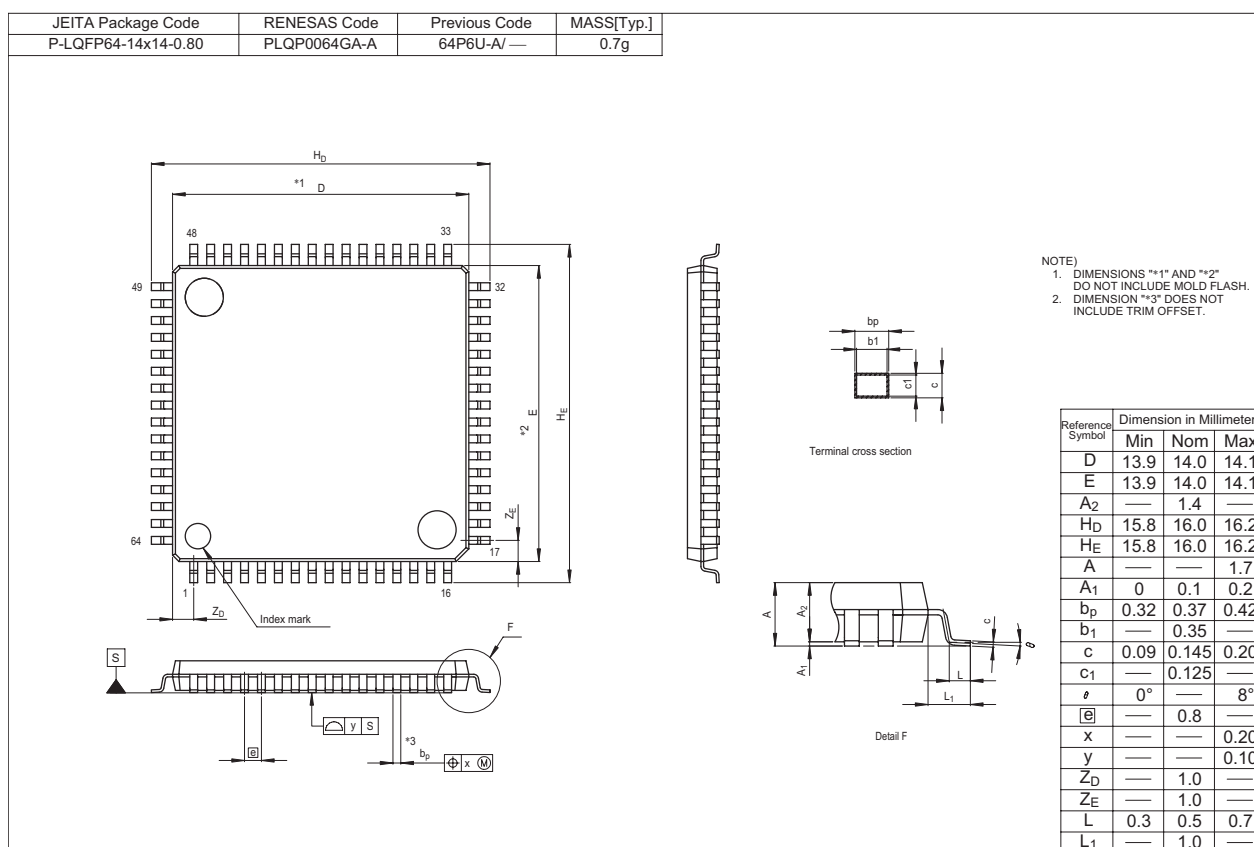
Table 5.32 Electrical Characteristics (6) [$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$]
($T_{opr} = -20\text{ to }85\text{ }^{\circ}\text{C}$ (N version)/ $-40\text{ to }85\text{ }^{\circ}\text{C}$ (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
I _{CC}	Power supply current ($V_{CC} = 1.8\text{ to }2.7\text{ V}$) Single-chip mode, output pins are open, other pins are V _{SS}	High-speed clock mode	—	2.2	—	mA
		High-speed clock mode	—	0.8	—	mA
		High-speed on-chip oscillator mode	—	2.5	10	mA
		High-speed on-chip oscillator mode	—	1.7	—	mA
		High-speed on-chip oscillator mode	—	1	—	mA
		Low-speed on-chip oscillator mode	—	90	300	μA
		Low-speed clock mode	—	80	350	μA
		Low-speed clock mode	—	40	—	μA
		Wait mode	—	15	90	μA
		Wait mode	—	4	80	μA
		Wait mode	—	3.5	—	μA
		Stop mode	—	2.0	5	μA
		Stop mode	—	15	—	μA

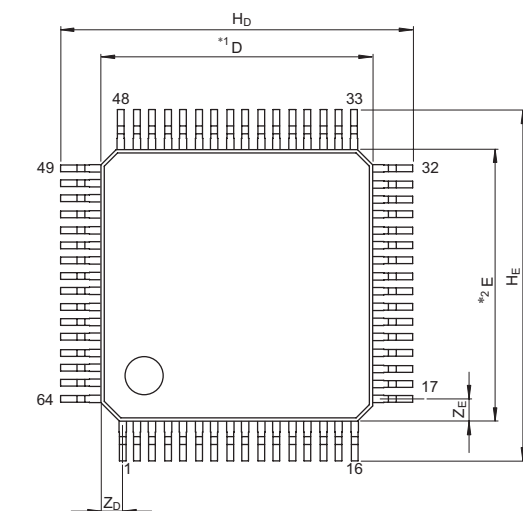
Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the “Packages” section of the Renesas Electronics website.

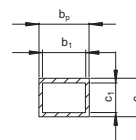




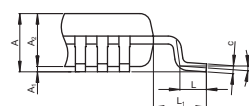
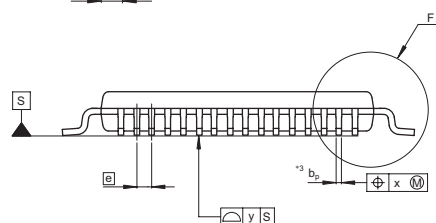
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TQFP64-7x7-0.40	PTQP0064LB-A	—	0.14g



NOTE)
1. DIMENSIONS**1"AND**2"
DO NOT INCLUDE MOLD FLASH
2. DIMENSION**3"DOES NOT
INCLUDE TRIM OFFSET.



Terminal cross section



Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	6.9	7.0	7.1
E	6.9	7.0	7.1
A ₂	—	1.00	—
H _D	8.8	9.0	9.2
H _E	8.8	9.0	9.2
A	—	—	1.20
A ₁	0.05	0.10	0.15
b _p	0.13	0.18	0.23
b ₁	—	0.16	—
c	0.12	0.17	0.22
c ₁	—	0.15	—
θ	0°	—	8°
Ⓔ	—	0.40	—
x	—	—	0.07
y	—	—	0.08
Z _D	—	0.50	—
Z _E	—	0.50	—
L	0.35	0.50	0.65
L ₁	—	1.00	—

REVISION HISTORY	R8C/36C Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.01	Oct 30, 2009	—	First Edition issued
1.00	Nov 02, 2010	All pages 4 28 to 54	“Preliminary”, “Under development” deleted Table 1.3 revised “5. Electrical Characteristics” added
1.10	Nov 02, 2010	— 3 4 and 5 6 8 17 33 47 51 55 59	TN-R8C-A015A/E reflected Table 1.2 “Timer RG” and “Package” revised Tables 1.3 and 1.4 revised Figure 1.1 revised Figure 1.3 “PTQP0064LB-A” added Figure 3.1 “Part Number” revised Table 5.3 “tCONV”, “tSAMP” revised Table 5.21 revised Table 5.28 revised Table 5.35 revised Package (PTQP0064LB-A) added

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